PRODUCT / PROCESS CHANGE NOTIFICATION

| 1. PCN basic data | | |
|----------------------|----------------|--|
| 1.1 Company | life.augmented | STMicroelectronics International N.V |
| 1.2 PCN No. | | POWER AND DISCRETES/25/15623 |
| 1.3 Title of PCN | | ST Manufacturing Reshaping (P&D_16/GEN1_HV&_VHV/Industrial): Qualification of ST Singapore as new location for both Front End and EWS. |
| 1.4 Product Category | | PIs Refer to the impacted Product list. |
| 1.5 Issue date | | 2025-08-01 |

| 2. PCN Team | | |
|---------------------------|-------------------|--|
| 2.1 Contact supplier | | |
| 2.1.1 Name | PIKE EMMA | |
| 2.1.2 Phone | +44 1628896111 | |
| 2.1.3 Email | emma.pike@st.com | |
| 2.2 Change responsibility | | |
| 2.2.1 Product Manager | Angelo RAO | |
| 2.1.2 Marketing Manager | Paolo PETRALI | |
| 2.1.3 Quality Manager | Vincenzo MILITANO | |

| 3. Change | | |
|---------------------------------|--------------------|--|
| 3.1 Category | 3.2 Type of change | 3.3 Manufacturing Location |
| Manufacturing reshaping program | | ST AM8F (8"-Singapore) as Front End Plant ST SINGAPORE as EWS Plant |

| 4. Description of change | | | |
|---|--|---|--|
| | Old New | | |
| | | ST AM8F (8"-Singapore) as Front End Plant ST SINGAPORE as EWS Plant | |
| 4.2 Anticipated Impact on form,fit, function, quality, reliability or processability? | No Impact. The products guarantee the same quality and electrical characteristics as per current production. | | |

| 5. Reason / motivation for change | | |
|---|--------------------|--|
| 5.1 Motivation In the frame of ST manufacturing reshaping program (refer to Corporate PCI 15383 - Early Notification), following the continuous improvement of our service and to increase produ Capacity, ST Microelectronics is announcing the qualification of ST Singapore as new loof for both Front End and EWS. Please be advised that the enclosed list of products and day could be subject to change. Such modifications may occur as part of the ongoing transformation program and will be communicated as and when available. | | |
| 5.2 Customer Benefit | SERVICE CONTINUITY | |

| 6. Marking of parts / traceability of change | |
|--|---|
| 6.1 Description | Traceability of change will be ensured by an internal codification. |

| 7. Timing / schedule | |
|-------------------------------------|--------------|
| 7.1 Date of qualification results | 2026-11-13 |
| 7.2 Intended start of delivery | 2027-01-01 |
| 7.3 Qualification sample available? | Upon Request |

| 8. Qualification / Validation | | | |
|--|-------------|---------------|--|
| 8.1 Description | | | |
| 8.2 Qualification report and qualification results | In progress | Issue Date | |

| | 9. Attachments (additional documentations) |
|---|--|
| 15623 Public product.pdf 15623 Qualification Plan Details_P&D 16.pdf | |

| 10. Affected parts | | |
|---|-------------|--------------------------|
| 10. 1 Current | | 10.2 New (if applicable) |
| 10.1.1 Customer Part No 10.1.2 Supplier Part No | | 10.1.2 Supplier Part No |
| | SCT1000N170 | |

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